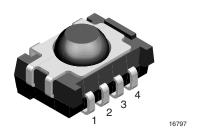


Vishay Semiconductors

### **IR Receiver Modules for Remote Control Systems**



#### **MECHANICAL DATA**

#### **Pinning**

 $1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$ 

#### **DESCRIPTION**

The TSOP62.., TSOP64.. series are miniaturized SMD-IR receiver modules for infrared remote control systems. PIN diode and preamplifier are assembled on a lead frame, the epoxy package is designed as IR filter.

The demodulated output signal can directly be decoded by a microprocessor. The TSOP62.. is compatible with all common IR remote control data formats. The TSOP64.. is optimized to better suppress spurious pulses from energy saving lamps but will also suppress some data signals.

This component has not been qualified according to automotive specifications.

#### **FEATURES**

- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Supply voltage: 2.7 V to 5.5 V
- · Output active low
- Low power consumption
- · High immunity against ambient light
- Low power consumption
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

# Pb-free



# RoHS

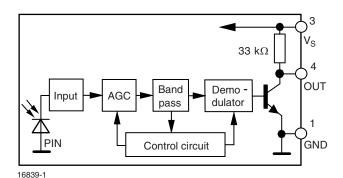
GREEN (5-2008)

#### **SPECIAL FEATURES**

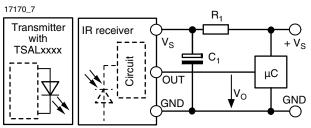
- · Improved immunity against ambient light
- Suitable burst length ≥ 10 cycles/burst
- · Taping available for top view and side view assembly

PARTS TABLE				
CARRIER FREQUENCY	STANDARD APPLICATIONS (AGC2/AGC8)	NOISY ENVIRONMENTS AND SHORT BURSTS (AGC4)		
30 kHz	TSOP6230	TSOP6430		
33 kHz	TSOP6233	TSOP6433		
36 kHz	TSOP6236	TSOP6436		
36.7 kHz	TSOP6237	TSOP6437		
38 kHz	TSOP6238	TSOP6438		
40 kHz	TSOP6240	TSOP6440		
56 kHz	TSOP6256	TSOP6456		

#### **BLOCK DIAGRAM**



#### **APPLICATION CIRCUIT**



The external components  $R_1$  and  $C_1$  are optional to improve the robustness against electrical overstress (typical values are  $R_1$  = 100  $\Omega,\,C_1$  = 0.1  $\mu F).$ 

The output voltage  $V_{\rm O}$  should not be pulled down to a level below 1 V by the external circuit.

The capacitive load at the output should be less than 2 nF.

www.vishay.com

### Vishay Semiconductors

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Supply voltage (pin 3)		Vs	- 0.3 to + 6	V	
Supply current (pin 3)		I <sub>S</sub>	5	mA	
Output voltage (pin 4)		Vo	- 0.3 to 5.5	V	
Voltage at output to supply		V <sub>S</sub> - V <sub>O</sub>	- 0.3 to (V <sub>S</sub> + 0.3)	V	
Output current (pin 4)		I <sub>O</sub>	5	mA	
Junction temperature		Tj	100	°C	
Storage temperature range		T <sub>stg</sub>	- 40 to + 100	°C	
Operating temperature range		T <sub>amb</sub>	- 25 to + 85	°C	
Power consumption	T <sub>amb</sub> ≤ 85 °C	P <sub>tot</sub>	10	mW	

#### Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

<b>ELECTRICAL AND OPTICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 3)	$E_{V} = 0, V_{S} = 5 V$	I <sub>SD</sub>	0.65	0.85	1.05	mA
	E <sub>v</sub> = 40 klx, sunlight	I <sub>SH</sub>		0.95		mA
Supply voltage		Vs	2.7		5.5	V
Transmission distance	$E_{v}=0$ , test signal see fig. 1, IR diode TSAL6200, $I_{F}=400~\text{mA}$	d		40		m
Output voltage low (pin 4)	I <sub>OSL</sub> = 0.5 mA, E <sub>e</sub> = 0.7 mW/m <sup>2</sup> , test signal see fig. 1	V <sub>OSL</sub>			100	mV
Minimum irradiance	Pulse width tolerance: $t_{pi}$ - 5/f <sub>0</sub> < $t_{po}$ < $t_{pi}$ + 6/f <sub>0</sub> , test signal see fig. 1	E <sub>e min.</sub>		0.3	0.45	mW/m²
Maximum irradiance	$t_{pi}$ - 5/f <sub>0</sub> < $t_{po}$ < $t_{pi}$ + 6/f <sub>0</sub> , test signal see fig. 1	E <sub>e max.</sub>	30			W/m <sup>2</sup>
Directivity	Angle of half transmission distance	Ψ1/2		± 50		deg

#### **TYPICAL CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

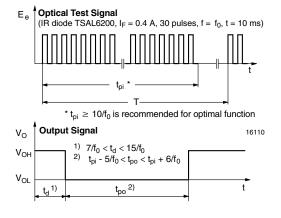


Fig. 1 - Output Active Low

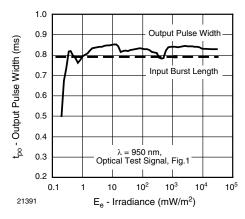
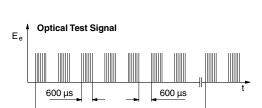
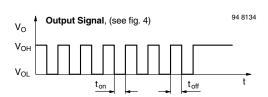


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

### Vishay Semiconductors





t = 60 ms

Fig. 3 - Output Function

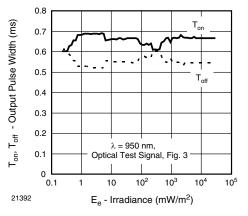


Fig. 4 - Output Pulse Diagram

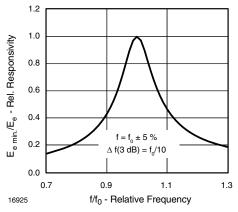


Fig. 5 - Frequency Dependence of Responsivity

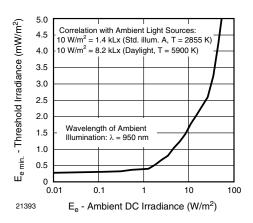


Fig. 6 - Sensitivity in Bright Ambient

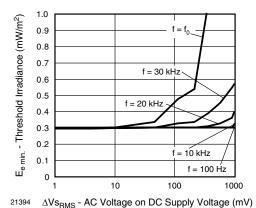


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

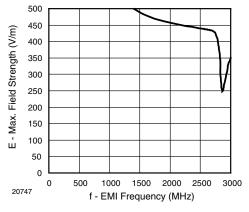


Fig. 8 - Sensitivity vs. Electric Field Disturbances

# Vishay Semiconductors



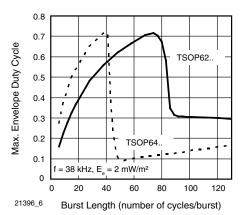


Fig. 9 - Max. Envelope Duty Cycle vs. Burst Length

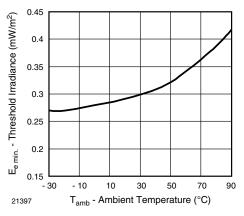


Fig. 10 - Sensitivity vs. Ambient Temperature

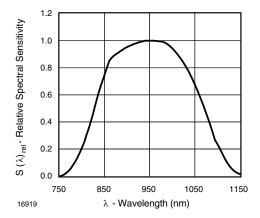


Fig. 11 - Relative Spectral Sensitivity vs. Wavelength

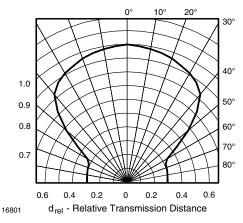


Fig. 12 - Horizontal Directivity

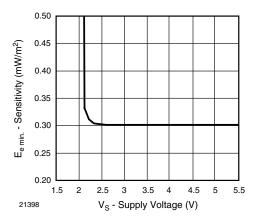


Fig. 13 - Sensitivity vs. Supply Voltage



### Vishay Semiconductors

#### **SUITABLE DATA FORMAT**

The TSOP62.., TSOP64.. series are designed to suppress spurious output pulses due to noise or disturbance signals. Data and disturbance signals can be distinguished by the devices according to carrier frequency, burst length and envelope duty cycle. The data signal should be close to the band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the TSOP62.., TSOP64.. in the presence of a disturbance signal, the sensitivity of the receiver is reduced to insure that no spurious pulses are present at the output. Some examples of disturbance signals which are suppressed are:

- DC light (e.g. from tungsten bulb or sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated noise from fluorescent lamps with electronic ballasts (see figure 14 or figure 15)

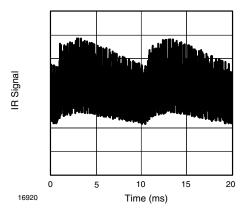


Fig. 14 - IR Signal from Fluorescent Lamp with Low Modulation

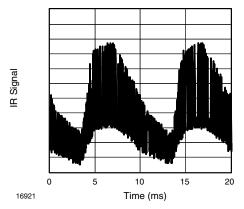


Fig. 15 - IR Signal from Fluorescent Lamp with High Modulation

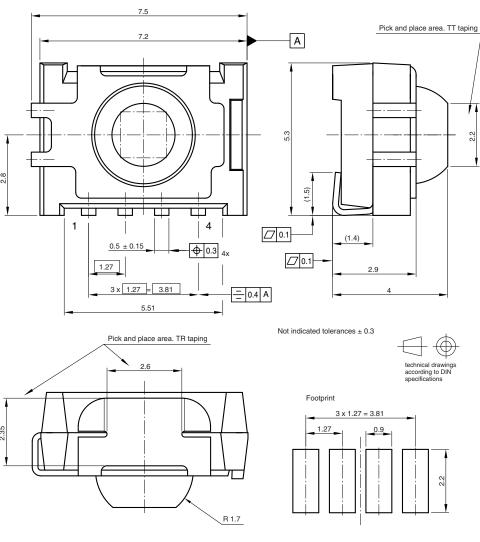
	TSOP62	TSOP64
Minimum burst length	10 cycles/burst	10 cycles/burst
After each burst of length a minimum gap time is required of	10 to 70 cycles ≥ 12 cycles	10 to 35 cycles ≥ 12 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 4 x burst length	35 cycles > 10 x burst length
Maximum number of continuous short bursts/second	800	1300
Recommended for NEC code	yes	yes
Recommended for RC5/RC6 code	yes	yes
Recommended for Sony code	yes	no
Recommended for Thomson 56 kHz code	yes	yes
Recommended for Mitsubishi code (38 kHz, preburst 8 ms, 16 bit)	yes	yes
Recommended for Sharp code	yes	yes
Suppression of interference from fluorescent lamps	Most common disturbance signals are suppressed	Even extreme disturbance signals are suppressed

#### Note

• For data formats with short bursts please see the datasheet of TSOP61.., TSOP63..

### Vishay Semiconductors

### **PACKAGE DIMENSIONS** in millimeters



Drawing-No.: 6.544-5341.01-4 Issue: 8; 02.09.09

#### **ASSEMBLY INSTRUCTIONS**

### **Reflow Soldering**

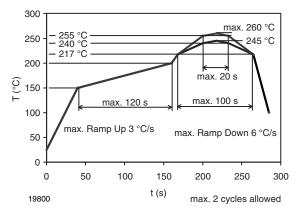
- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Excercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

#### **Manual Soldering**

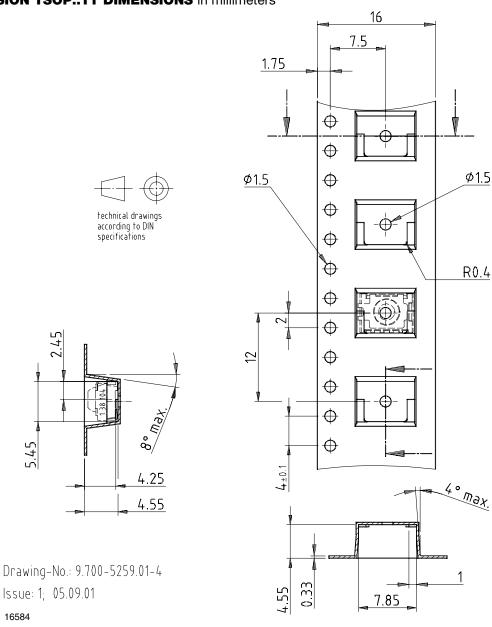
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

### Vishay Semiconductors

### **VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE**

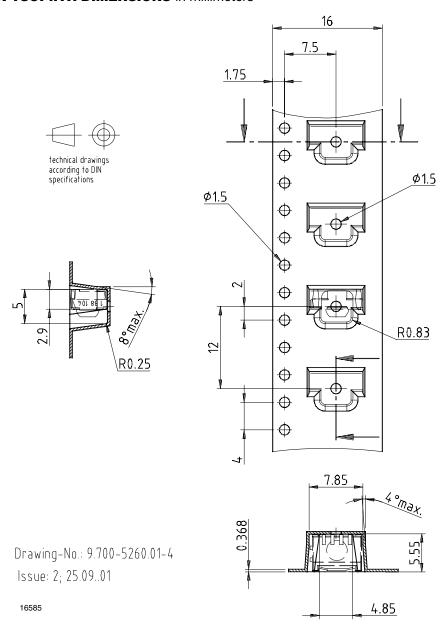


#### **TAPING VERSION TSOP..TT DIMENSIONS** in millimeters



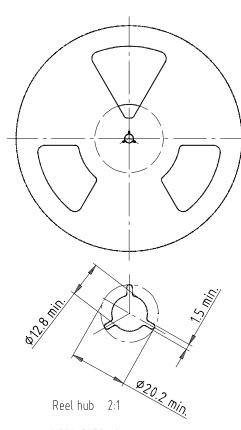
### Vishay Semiconductors

### TAPING VERSION TSOP..TR DIMENSIONS in millimeters



### Vishay Semiconductors

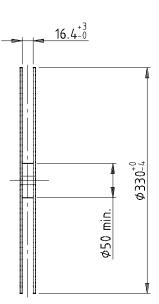
#### **REEL DIMENSIONS** in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734



Form of the leave open of the wheel is supplier specific.

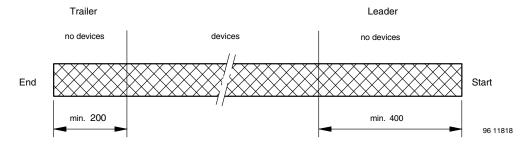
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

#### **LEADER AND TRAILER DIMENSIONS** in millimeters



#### **COVER TAPE PEEL STRENGTH**

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. ± 10 mm/min. 165° to 180° peel angle

#### **LABEL**

#### Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

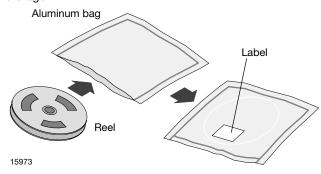


### Vishay Semiconductors

		DUCT LABEL (finished goods)
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

#### **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



#### **FINAL PACKING**

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

#### RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

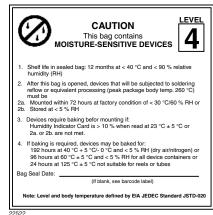
After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40  $^{\circ}$ C + 5  $^{\circ}$ C/- 0  $^{\circ}$ C and < 5  $^{\circ}$ RH (dry air/nitrogen)

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags.



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags



### Vishay Semiconductors

#### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

# VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22645



### **Legal Disclaimer Notice**

Vishay

### **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

### **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.